

AGENDA

ACH Committee Meeting Austin, TX Sheraton Austin Hotel at the Capitol September 30, 2010

1. Call to order
2. Membership & Attendance – Introductions
3. Approval of Agenda
4. Approval of April 29, 2010 minutes
5. Correspondence
6. Report from ECA—Ed Mikoski
7. Sub-Committee & Working Group Reports
 - 7.1 Snapshot of current projects and documents--Scott Carter
 - 7.2 Status of Errata sheet—Rectangular QFN and BGA packages; ESD S541 reference
 - 7.3 Small Width/Pitch Task Force (PN 5081)—Discussion of IEC TC40/WG36 proposal for 4-mm wide x 1-mm pitch tapes—Charles Gutentag
 - 7.4 ESD Task Force—James Adams
 - 7.5 Tape Splicing—B. Aldeen, H. Sipes, E. Bishop
 - 7.6 ACH Knowledge Base—Bill Aldeen, James Adams, Henry Sipes
Camber
Cover Tape Split Peel Force
Tape Baking
8. Guest Presentation—Rob Sierra, Sierra Electronics, “Tape Splice Technologies Past and Present”
9. New Business
 - 9.1 Review EIA-948—Nokia
10. Old Business
 - 10.1 EIA-960 (PN-5088) Ballot—H. Sipes
 - 10.2 Cover Tape Peel Force Speed—H. Sipes
 - 10.3 Strategic Planning—SWOT analysis results and follow up
 - 10.4 Marketing and new membership update—ECA website, Workshops, IEC TC40/WG36 joint meeting in Seattle.
11. Future Meeting-Place ???, Spring 2011
12. Adjournment